

# RJK6002DPE

600V - 2A - MOS FET  
High Speed Power Switching

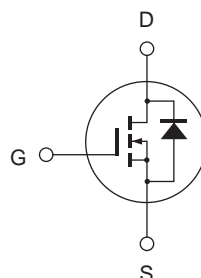
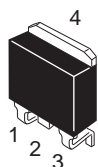
R07DS0214EJ0100  
Rev.1.00  
Jun 21, 2012

## Features

- Low on-resistance  
 $R_{DS(on)} = 5.7 \Omega$  typ. (at  $I_D = 1$  A,  $V_{GS} = 10$  V,  $T_a = 25^\circ\text{C}$ )
- Low drive current
- High density mounting

## Outline

RENESAS Package code: PRSS0004AE-B  
(Package name: LDKPAK(S)-(1) )



1. Gate
2. Drain
3. Source
4. Drain

## Absolute Maximum Ratings

( $T_a = 25^\circ\text{C}$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	600	V
Gate to source voltage	$V_{GSS}$	$\pm 30$	V
Drain current	$I_D$	2	A
Drain peak current	$I_{D(pulse)}$ <sup>Note1</sup>	4	A
Body-drain diode reverse drain current	$I_{DR}$	2	A
Body-drain diode reverse drain peak current	$I_{DR(pulse)}$ <sup>Note1</sup>	4	A
Avalanche current	$I_{AP}$ <sup>Note3</sup>	1	A
Avalanche energy	$E_{AR}$ <sup>Note3</sup>	0.05	mJ
Channel dissipation	$P_{ch}$ <sup>Note2</sup>	35	W
Channel to case thermal impedance	$\theta_{ch-c}$	3.57	$^\circ\text{C/W}$
Channel temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

Notes: 1.  $PW \leq 10 \mu\text{s}$ , duty cycle  $\leq 1\%$   
 2. Value at  $T_c = 25^\circ\text{C}$   
 3.  $STch = 25^\circ\text{C}$ ,  $T_{ch} \leq 150^\circ\text{C}$

## Electrical Characteristics

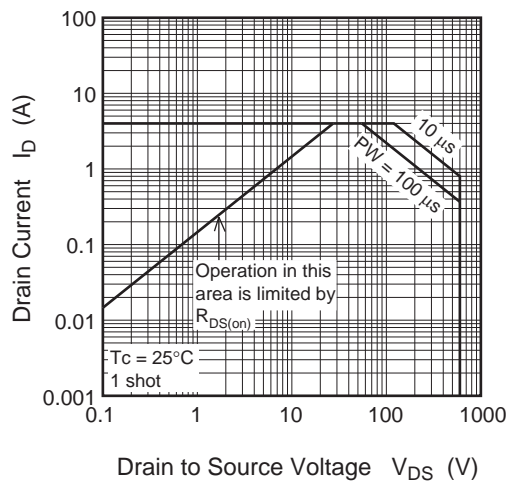
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	600	—	—	V	$I_D = 10 \text{ mA}$ , $V_{GS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	1	$\mu\text{A}$	$V_{DS} = 600 \text{ V}$ , $V_{GS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	$\pm 0.1$	$\mu\text{A}$	$V_{GS} = \pm 30 \text{ V}$ , $V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	3.0	—	4.5	V	$V_{DS} = 10 \text{ V}$ , $I_D = 1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	5.7	6.8	$\Omega$	$I_D = 1 \text{ A}$ , $V_{GS} = 10 \text{ V}$ <sup>Note4</sup>
Input capacitance	$C_{iss}$	—	165	—	pF	$V_{DS} = 25 \text{ V}$ $V_{GS} = 0$ $f = 1 \text{ MHz}$
Output capacitance	$C_{oss}$	—	20	—	pF	
Reverse transfer capacitance	$C_{rss}$	—	2.5	—	pF	
Turn-on delay time	$t_{d(on)}$	—	28	—	ns	$I_D = 1 \text{ A}$ $V_{GS} = 10 \text{ V}$ $R_L = 300 \Omega$ $R_g = 10 \Omega$
Rise time	$t_r$	—	17	—	ns	
Turn-off delay time	$t_{d(off)}$	—	47	—	ns	
Fall time	$t_f$	—	20	—	ns	
Total gate charge	$Q_g$	—	9.2	—	nC	$V_{DD} = 480 \text{ V}$ $V_{GS} = 10 \text{ V}$ $I_D = 2 \text{ A}$
Gate to source charge	$Q_{gs}$	—	1.2	—	nC	
Gate to drain charge	$Q_{gd}$	—	6.1	—	nC	
Body-drain diode forward voltage	$V_{DF}$	—	0.87	1.45	V	$I_F = 2 \text{ A}$ , $V_{GS} = 0$ <sup>Note4</sup>
Body-drain diode reverse recovery time	$t_{rr}$	—	260	—	ns	$I_F = 2 \text{ A}$ , $V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

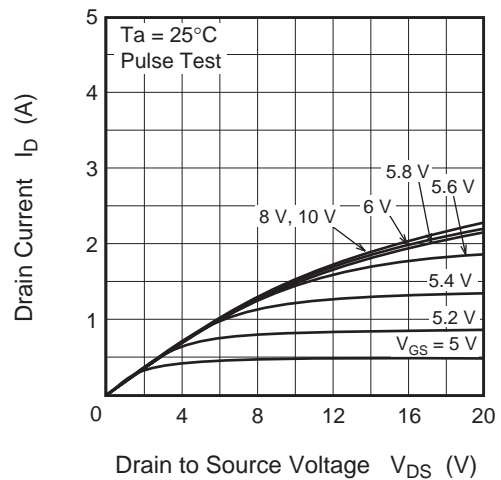
Notes: 4. Pulse test

## Main Characteristics

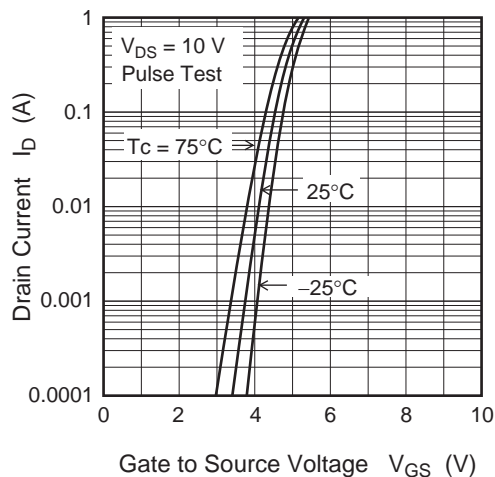
Maximum Safe Operation Area



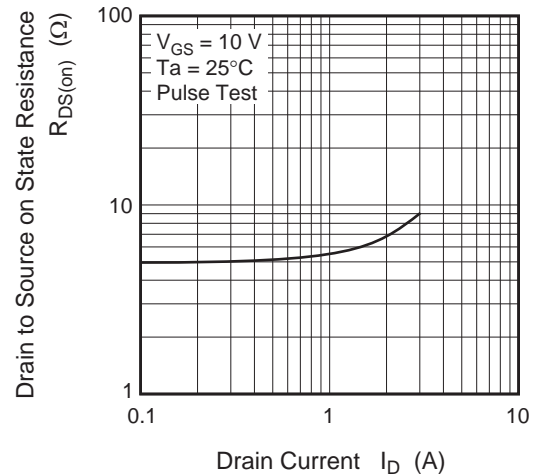
Typical Output Characteristics



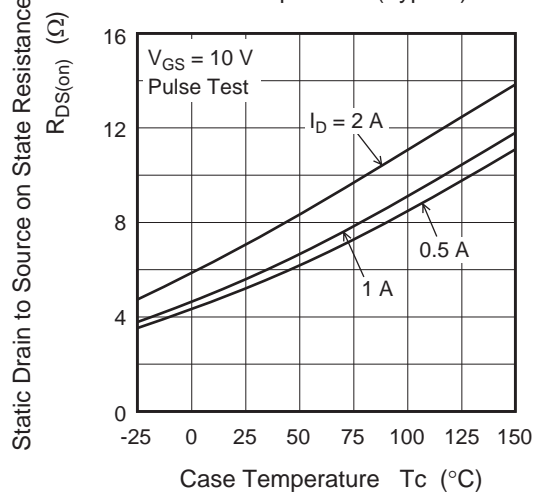
Typical Transfer Characteristics



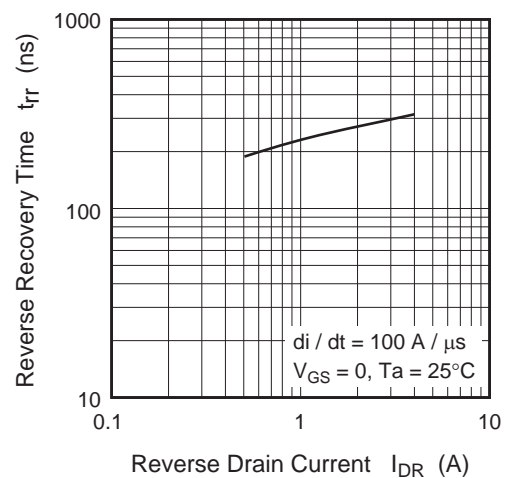
Static Drain to Source on State Resistance vs. Drain Current (Typical)

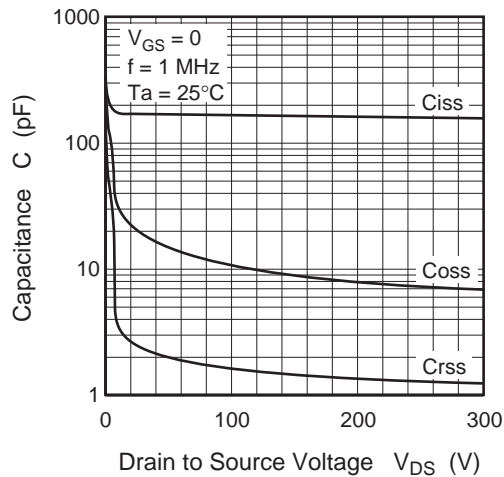


Static Drain to Source on State Resistance vs. Temperature (Typical)

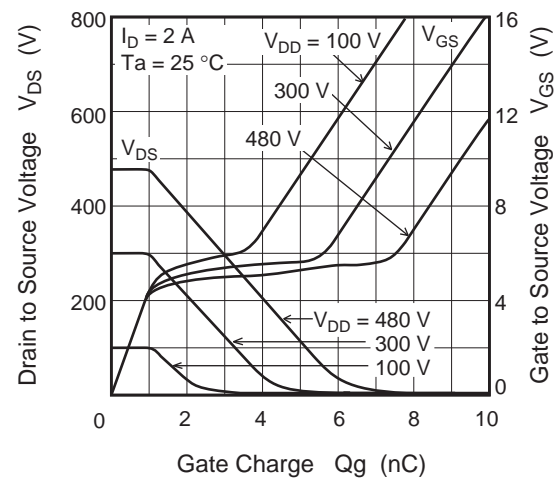
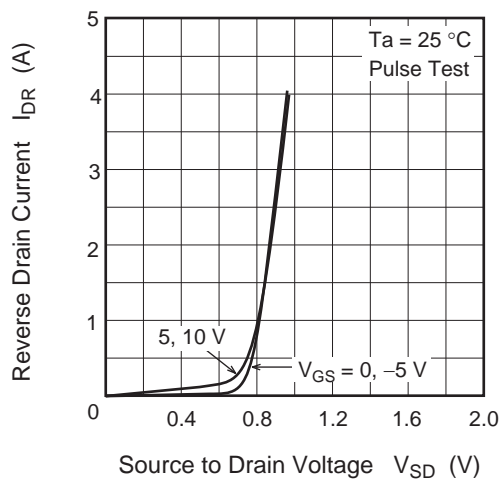
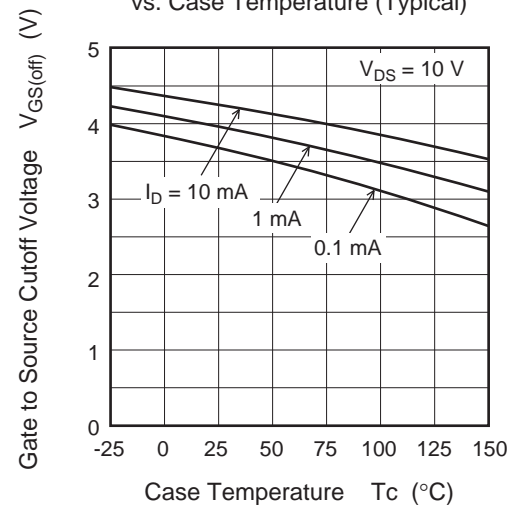


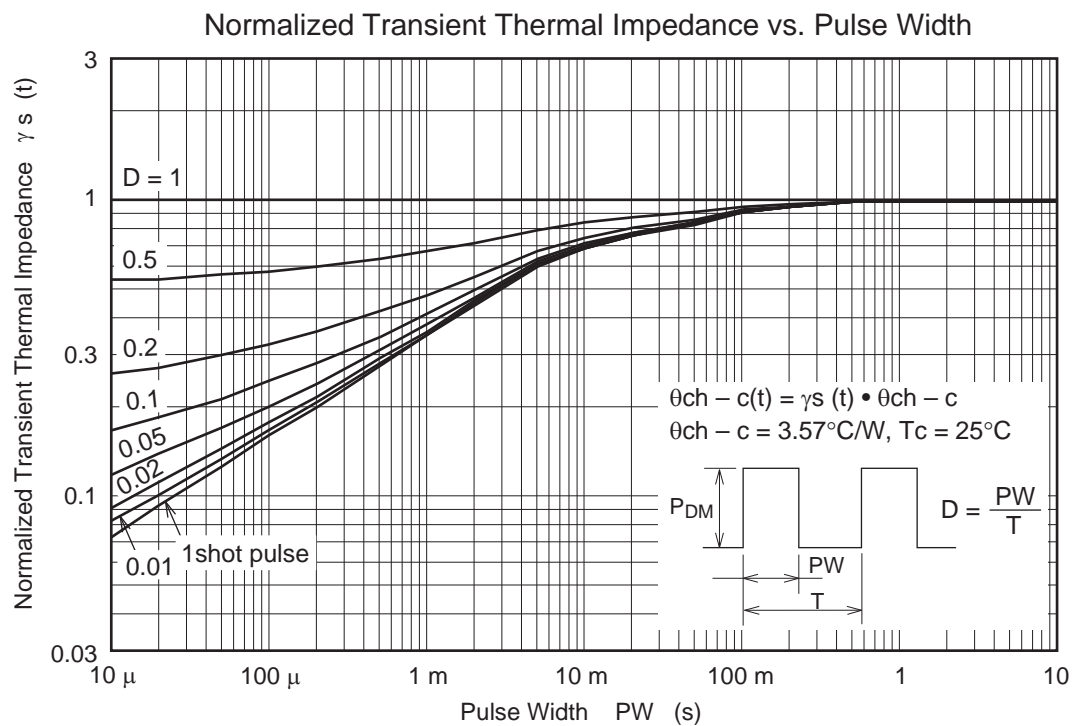
Body-Drain Diode Reverse Recovery Time (Typical)



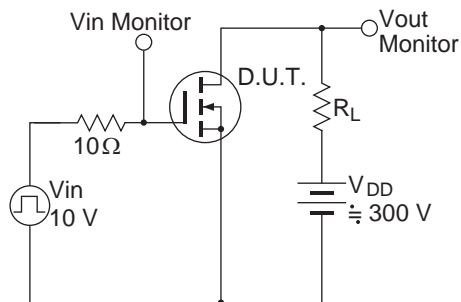
Typical Capacitance vs.  
Drain to Source Voltage

Dynamic Input Characteristics (Typical)

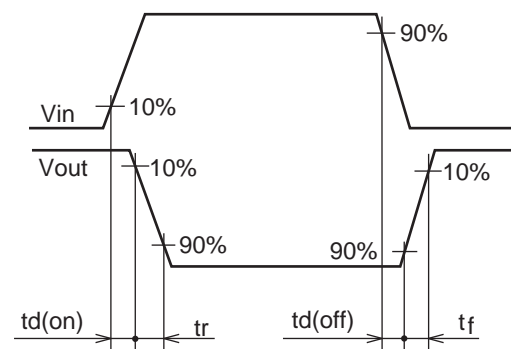
Reverse Drain Current vs.  
Source to Drain Voltage (Typical)Gate to Source Cutoff Voltage  
vs. Case Temperature (Typical)



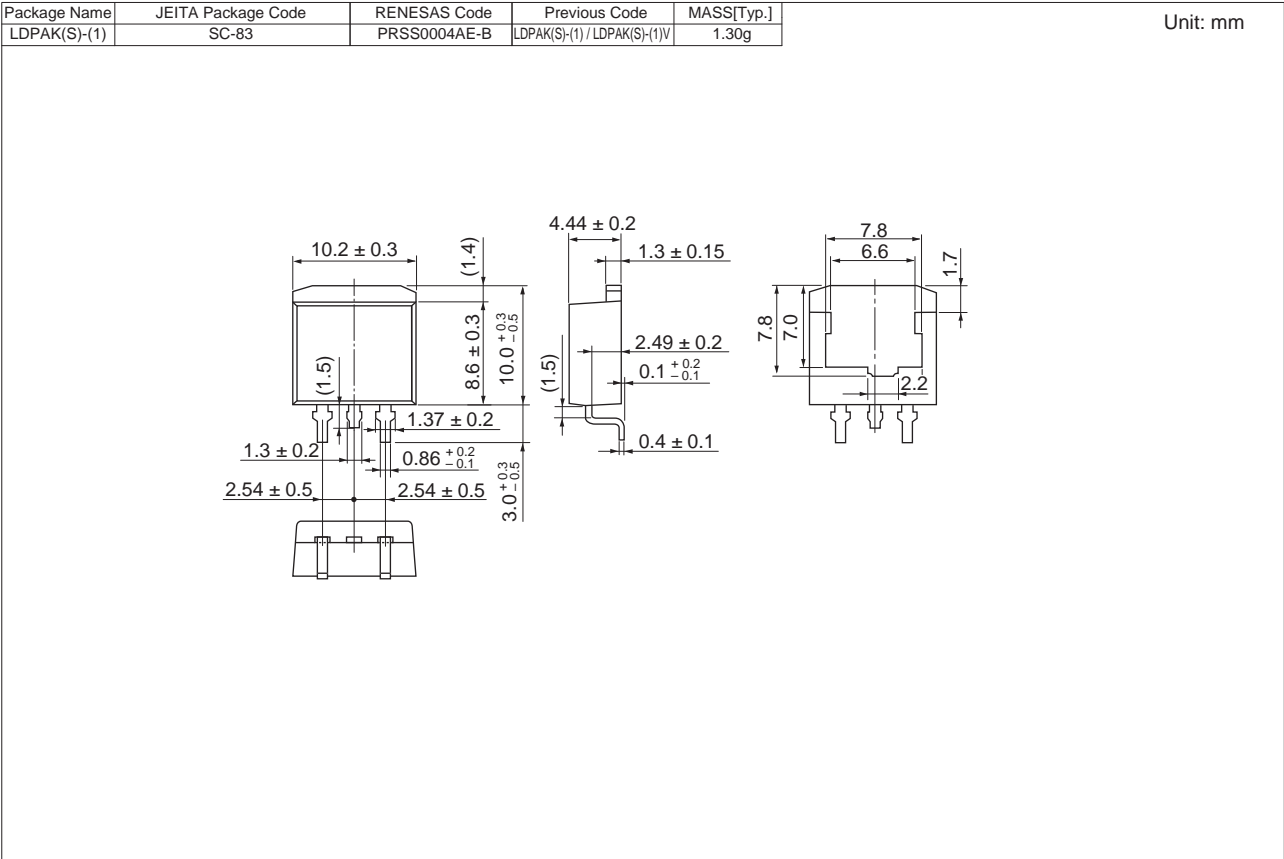
Switching Time Test Circuit



Waveform



Package Dimensions



Ordering Information

Orderable Part Number	Quantity	Shipping Container
RJK6002DPE-00#J3	1000 pcs	Taping

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